

PRM7R5N03D

PFC Device Corporation

30V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	30	٧
$I_D^4 (T_C=25^{\circ}C)$	69	Α
Max. R _{DS(ON)} @V _{GS} =10V	7.5	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	9.7	mΩ
T _J Operating Junction Temperature	-55 to +150	°C

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

PRM7R5N03D TO-252 (D-PAK)

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. $R_{DS(ON)}=7.5m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±20	V
l _D ⁴	Drain Current – Continuous (T _C =25°C)	69	Α
ID	Drain Current – Continuous (T _C =100°C)	44	Α
I_D^5	Drain Current – Continuous (T _C =25°C)	60	Α
I _{DM}	Drain Current – Pulsed ¹	240	Α
В	Power Dissipation (T _C =25°C)	57	W
P _D	Power Dissipation – Derate above 25°C	0.45	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{ hetaJA}$	Thermal Resistance Junction to ambient		50	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		2.2	°C/W



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Electrical Characteristics

($T_J = 25$ °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30			V
	Drain Source Leekage Current	V _{DS} =24V, V _{GS} =0V, T _J =25°C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V, V _{GS} =0V, T _J =125°C			5	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA

On Characteristics

R _{DS(ON)} Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A		6.2	7.5	mΩ	
$R_{DS(ON)}$	Static Dialii-Source On-Nesistance	V _{GS} =4.5V, I _D =10A		8.0	9.7	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.6	2.5	V
g_{fs}	Forward Transconductance	V_{DS} =5V, I_{D} =10A		45		S

Dynamic and switching Characteristics

Q_{g}	Total Gate Charge ^{2, 3}	V _{DS} =24V, V _{GS} =10V, I _D =20A		38	
Q_{qs}	Gate-Source Charge ^{2, 3}		-	5.0	 nC
Q_{gd}	Gate-Drain Charge ^{2, 3}			6.0	
$T_{d(on)}$	Turn-On Delay Time ^{2, 3}			15	
T_r	Turn-On Rise Time ^{2, 3}	V_{DD} =15V, V_{GS} =10V, R_{G} =2.5 Ω	-	90	 ns
$T_{d(off)}$	Turn-Off Delay Time ^{2, 3}			55	 115
T_f	Turn-Off Fall Time ^{2, 3}		-	82	
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	-	1150	
C _{oss}	Output Capacitance			200	 pF
C _{rss}	Reverse Transfer Capacitance		-	110	
R_{g}	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.3	 Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$V_{GS}=0V$, $I_{S}=1A$	 	1.0	V
t _{rr}	Reverse Recovery Time	1 201 di/dt 1001/up	 22		ns
Q_{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us	 50		nC

Note :

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$.
- 3. Essentially independent of operating temperature.
- 4. Silicon limited.
- 5. Package limited.



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2. Characteristics Curves

Ratings and Characteristics Curves

(T_A = 25° unless otherwise specified)

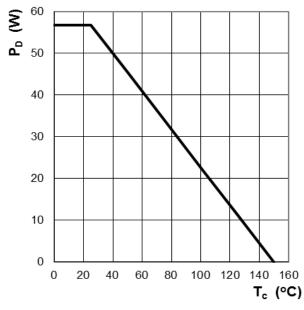


Figure 1: Power Dissipation

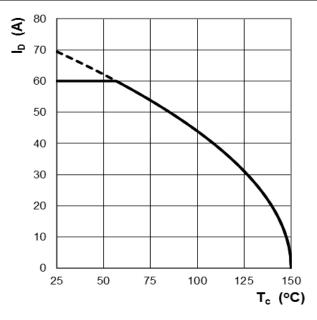


Figure 2: Continuous Drain Current vs. T_C

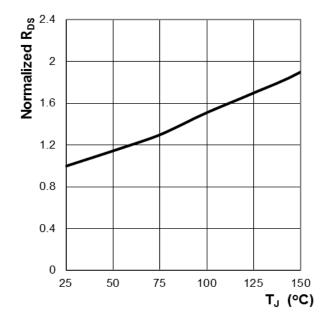


Figure 3: Normalized R_{DS(ON)} vs. T_J

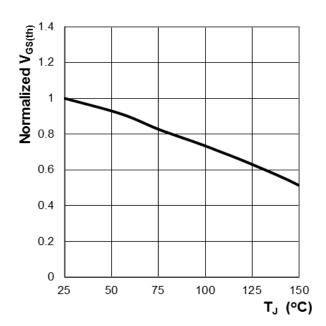


Figure 4: Normalized V_{GS(th)} vs. T_J



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Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)

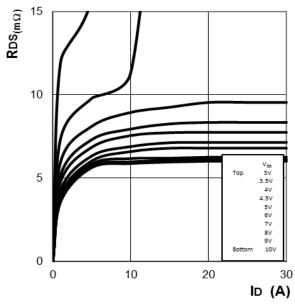


Figure 5: RDS(ON) vs. Drain Current and Gate Voltage

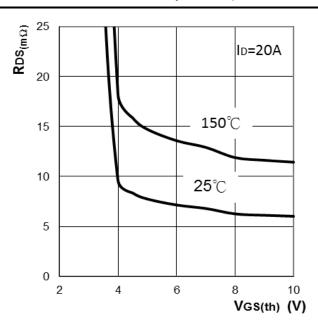


Figure 6: RDS(ON) vs. Gate Voltage

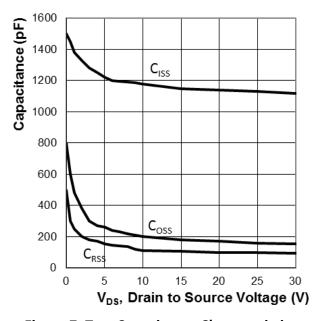


Figure 7: Typ. Capacitance Characteristics

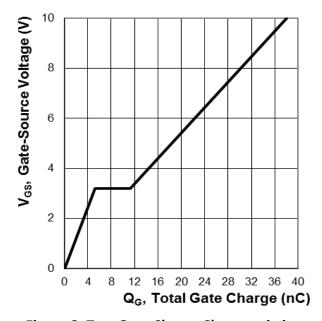


Figure 8: Typ. Gate Charge Characteristics



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Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

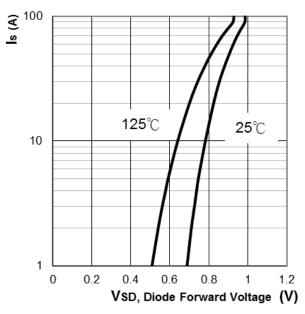


Figure 9: Body Diode Characters

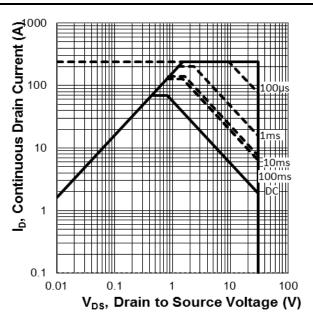


Figure 10: Maximum Safe Operation Area

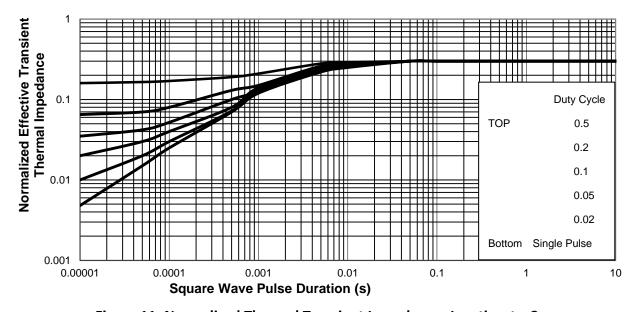


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



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3. Marking information

Top Marking Rule

PFC PRM 7R5N03D YYWW ABSH PRM7R5N03D = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

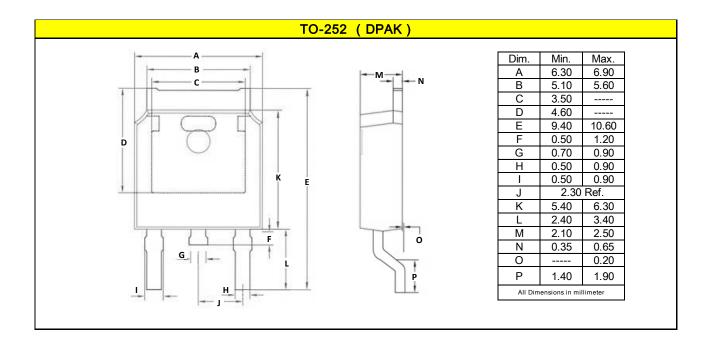
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters





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5. Ordering information

Part Number	Package	Delivery mode
PRM7R5N03D	TO-252 (D-PAK)	2500 pcs / 13" diameter reel

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0

Device Weight: 0.01 ounces (0.3grams) - TO-252 (D-PAK)

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